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RESPONSE UNDER 37 CFR 1.116
EXPEDITED PROCEDURE
EXAMINING GROUP 2815

PATENT APPLICATION
Docket No.: 9898-341
Client Ref. No.: SS-18733-US-RCE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Dong-Kil SHIN, et al.

Serial No.: 10/772,651 Examiner: Warren, Matthew E.

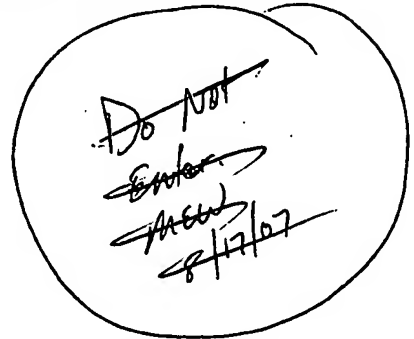
Filed: February 4, 2004 Group Art Unit: 2815

Confirmation No.: 5815

For: MULTI-CHIP PACKAGE WITH SOFT ELEMENT AND METHOD OF
MANUFACTURING THE SAME

Date: August 3, 2007

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450



AMENDMENT AFTER FINAL REJECTION UNDER 37 CFR 1.116

Responsive to the Final Office Action, Paper No. 20061122, dated June 4, 2007, please amend the application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.